☐ MN101D09E

Туре	MN101D09E	MN101DF09G			
Internal ROM type	Mask ROM	FLASH			
ROM (byte)	80K	128K			
RAM (byte)	2K	4K			
Package (Lead-free)	QFP100-P-1818B				
Minimum Instruction Execution Time	[With main clock operated] 0.1397 µs (at 4.0 V to 5.5 V, 14.32 MHz) 71.5 µs (at 2.7 V to 5.5 V, 14.32 MHz internal frequency di Vision) [When sub-clock operated] 61 µs (at 2.5 V to 5.5 V, 32.768 kHz)	0.1397 μs (at 4.0 V to 5.5 V, 14.32 MHz) 71.5 μs (at 2.7 V to 5.5 V, 14.32 MHz internal frequency di Vision) 61 μs (at 2.5 V to 5.5 V, 32.768 kHz)			

Interrupts

RESET, Runaway, External 0 to 4, Timer 0 to 3, Timer 6, Capstan FG, Control, HSW, Cylinder(Drum) FG, Servo V-sync, Synchronous output, OSD, XDS, Serial 1, Serial 2, PWM 4, OSD V-sync

■ Timer Counter

Timer counter 0 : 8-bit \times 1 (timer function)

Timer counter 1 : 8-bit \times 1 (timer function, linear timer counter function)

Interrupt source overflow of timer counter 1

Timer counter 2: 16-bit × 1 (timer function, input capture (CTL specified edge), duty judgment of CTL signal)

Interrupt source overflow of timer counter 2; input of CTL specified edge; underflow of timer 2 shift register 4-bit counter;

coincidence of timer 2 shift register with timer 2 shift register compare register

Timer counter 3 : 16-bit × 1 (timer function)

Clock source......1/4, 1/16 of system clock frequency

Interrupt source overflow of timer counter 3

Timer counter 5:19-bit \times 1 (watchdog, stable oscillation waiting function)

Clock source..... system clock

Watchdog interrupt source... 1/2¹⁶, 1/2¹⁹ of timer counter 5 frequency

Clear by stable oscillation ... after 256 counts by timer counter 5 (2^{18} counts of OSC oscillation clock)

Timer counter 6: 16-bit × 1 (clock function [max. 2 s])

Interrupt source $1/2^{13}$, $1/2^{14}$, $1/2^{15}$ overflow of timer counter 6

Serial interface

Serial 1: 8-bit × 1 (synchronous type)

(transfer direction of MSB/LSB selectable, start condition function)

Serial 2 : 8-bit \times 1 (I²C)

(master transmission/reception, slave transmission/reception)

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■ OSD

Display mode	Menu(Internal synchronized) display, super impose(external synchronized) display
Applicable broadcasting system	NTSC, PAL, PAL-M, PAL-N
Screen configuration	24 characters \times 2n rows (n = 1 to 6)
Character type	max. 128 character types (variable, include special characters)
Character size	12 × 18 dots (Vertical direction : 1 dot for 2H at not enlargement)
Enlarged characters	each × 2 settings in horizontal and vertical
Character interpolation	none
Line background color	8-hue settable in the row unit at menu display
Line background intensity	8 gradations settable in the row unit
Screen background color	8-hue settable at omenu display
Character color	white
Character intensity	8 gradations settable in the row unit
Frame function	1-dot frame in 4 directions
Frame intensity	4 gradations settable in the row unit
Blinking	none (covered by software)
Inverted character	settable in the character unit
Halftone	none
Input	composite video signal input (output level : 1 V[p-p] / 2 V[p-p])
Clamp method	sync tip clamp, clamp level in 4 levels
Output	composite video output
Measure against image fluctuation	built-in AFC circuit
Dot clock	1/2 of OSC oscillation clock (automatic phase adjustment)

■ XDS

Built-in U.S. closed caption data slicer (optional 1 line data can be extracted.)

■ I/O Pins

I/O	56	Common use: 45
Input	1	Common use: 1

■ A/D converter

8-bit \times 11-ch. (without S/H)

■ PWM

13-bit \times 2-ch. (at repetition cycle 572 ms at 14.32 MHz), 8-bit \times 1-ch. (at repetition cycle 71.5 ms, 0.572 ms, 1.14 ms, 2.29 ms at 14.32 MHz)

■ ICR

16-bit × 2-ch.(Speed system), 18-bit × 4-ch.(Phase system)

OCR

16-bit \times 3 (Synchronous output \times 2, Rec CTL \times 1)

■ Special Ports

3-state output (PTO) VLP pin; CTL input; Capstan FG input; Cylinder(Drum) PG/FG inputs; HSW output; Head amp/ Rotary control outputs; output of 1/4 OSC oscillation clock (1 V[p-p])

■ ROM Correction

Correcting address designation: up to 3 addresses possible

Correction method: correction program being saved in internal RAM

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■ Electrical Charactreistics (Supply current)

Parameter	Symbol	Condition	Limit			Unit
			min	typ	max	Oill
Operating supply current	IDD1	14.32 MHz operation without load, VDD = 5 V		50	100	mA
	IDD2	1/1024 of 14.32 MHz operation without load, VDD = 2.7 V		2	5	mA
	IDD3	Stop of 14.32 MHz oscillation, VDD = 2.7 V 32 kHz oscillation operation without load		50	100	μΑ
Supply current at STOP	IDSP	Stop of oscillation without load, VDD = 5 V			10	μΑ
Supply current at HALT	IDHT0	14.32 MHz oscillation without load, VDD = 5 V		5	15	mA
	IDHT1	Stop of 14.32 MHz oscillation, VDD = 2.7 V 32 kHz oscillation operation without load		5	20	μΑ

 $(Ta = 25^{\circ}C\pm 2^{\circ}C, VSS = 0 V)$

■ Electrical Charactreistics (A/D converter characteristics)

Parameter	Symbol	Condition	Limit			Unit
			min	typ	max	Offic
Conversion relative error	ΔNLAD				±3	LSB
A/D Conversion Time	tAD	fosc = 14.32 MHz		8		μs
Analog Input Voltage					5	V

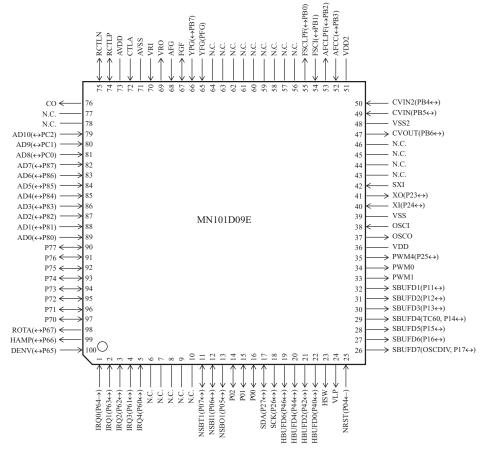
 $(Ta = 25^{\circ}C \pm 2^{\circ}C, VDD = 5.0 \text{ V}, VSS = 0 \text{ V})$

■ Development tools

In-circuit Emulator PX-ICE101C/D + PX-PRB101D08-QFP100-P-1818B-M

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■ Pin Assignment



QFP100-P-1818B

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